

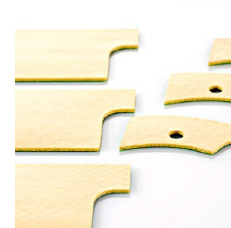
## Overview:

SOFTTHERM® compressible thermally conductive silicone pad series are designed to be highly conductive that provide well-balanced thermal, electrical, dielectric and low outgassing behaviour, also provide good surface conformability with good inherent tack characteristics.

Applications that required better mechanical strength can be achieved through fiberglass reinforcement and adhesive coating is an optional availability.

## Applications:

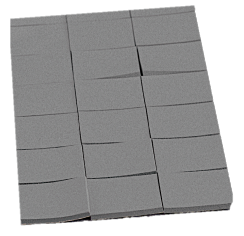
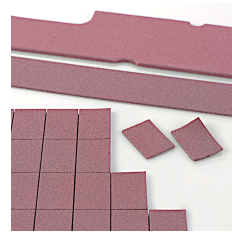
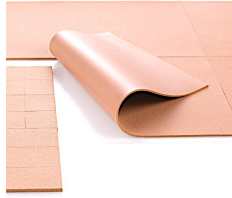
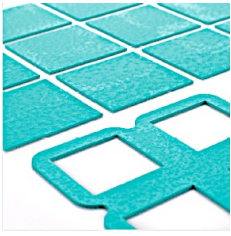
■ Automotive ■ Telecommunication ■ Power Supplies ■ Audio and Video Components ■ White Goods



## Non-Reinforced Compressible Thermally Conductive Silicone Pad

Properties	Unit	86/125	86/225	86/235	86/300	86/320	Test Method
Colour	-	Orange	Orange	Yellow	Blue	Yellow	Visual
Reinforcement	-	None	None	None	None	None	Visual
<b>Thermal Properties</b>							
Thermal resistance $R_{th}$	K/W	0.08	0.6	0.6	0.41	0.5	Kerafol
Thermal impedance $R_{ti}$	$^{\circ}\text{Cmm}^2/\text{W}$	322	240	240	164	147	Kerafol
	$\text{Kin}^2/\text{W}$	0.5	0.37	0.37	0.25	0.23	Kerafol
Thermal conductivity $\lambda$	W/m-K	1.5	2.0	2.0	3.0	2.5	ASTM D5470
<b>Electrical Properties</b>							
Breakdown voltage $U_{d;ac}$	kV	6	6	6	7	5	ASTM D149
Dielectric breakdown $E_{d;ac}$	kV/mm	12	12	12	14	10	ASTM D149
Volume resistivity	$\Omega\text{m}$	$61.3 \times 10^9$	$2.2 \times 10^{11}$	$176.1 \times 10^9$	$1.0 \times 10^{11}$	$0.68 \times 10^{12}$	ASTM D257-3
Dielectric loss factor $\tan \sigma$	1	$153 \times 10^{-3}$	$1.0 \times 10^{-3}$	$20.2 \times 10^{-3}$	$5.0 \times 10^{-3}$	$29 \times 10^{-3}$	ASTM D150
Dielectric constant $\epsilon_r$	1	4.28	3.6	3.7	3.3	3.4	ASTM D150
<b>Mechanical Properties</b>							
Measured thickness (+/-10%)	mm	0.500	0.500	0.500	0.500	0.500	ASTM D734
Hardness	Shore 00	10 - 25	30 - 45	25 - 40	60 - 75	25 - 38	ASTM D2240
Young's Modulus	N/cm <sup>2</sup>	23.6	58	32	24	32	ASTM D412
<b>Physical Properties</b>							
Operating temperature	$^{\circ}\text{C}$	-40 to +180	-40 to +180	-40 to +180	-60 to +200	-40 to +180	Kerafol
Density	g/cm <sup>3</sup>	2.0	1.65	1.65	1.71	1.69	Kerafol
Flame rating	UL 94	VO	VO	VO	VO	VO	U.L. E140693
Total Mass Loss (TML)	Ma.-%	<0.29	<0.44	<0.10	<0.35	<0.46	ASTM E 595
Thickness available	mm	0.5 - 5.0	0.5 - 5.0	0.5 - 5.0	0.5 - 5.0	1.0 - 5.0	Kerafol

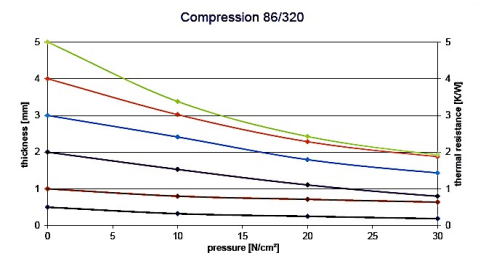
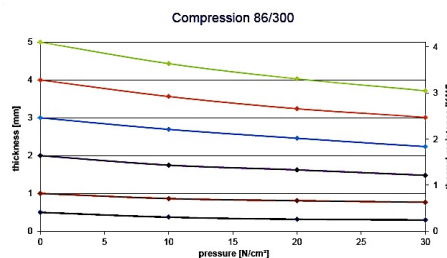
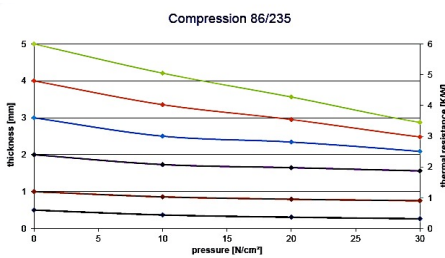
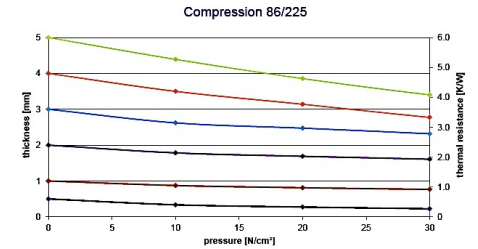
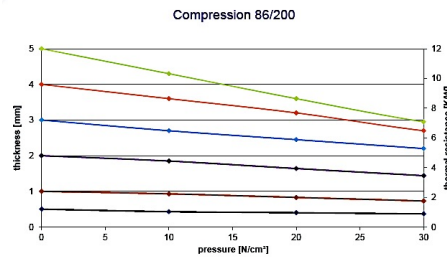
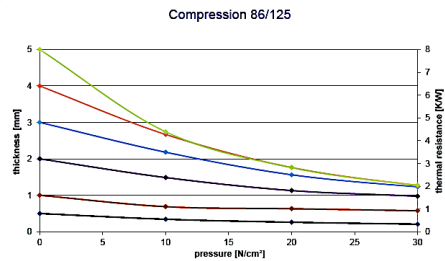
\* Data provided are nominal values that should not be used to write specifications. Users are advised to test and decide the suitability of the product to fit their applications.

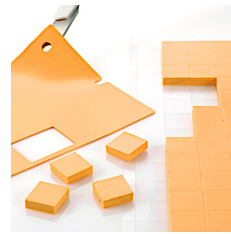
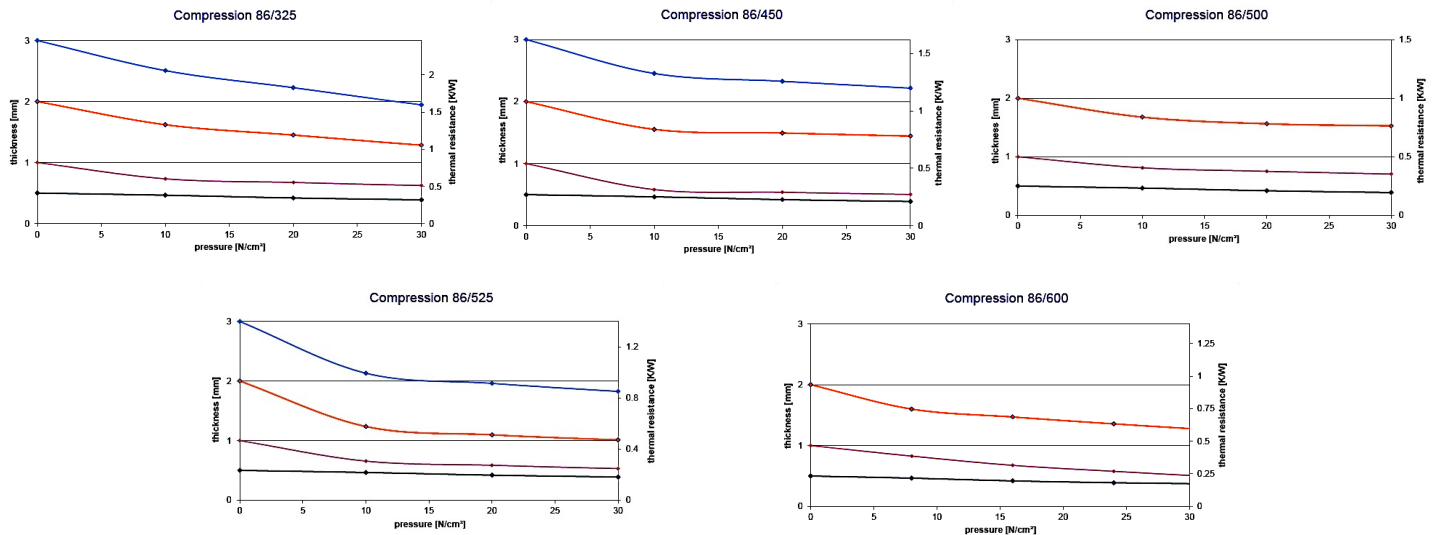


## Non-Reinforced Compressible Thermally Conductive Silicone Pad

Properties	Unit	86/325	86/450	86/500	86/525	86/600	Test Method
Colour	-	Mint	Brown	Brown	Violet	Grey	Visual
Reinforcement	-	None	None	None	None	None	Visual
<b>Thermal Properties</b>							
Thermal resistance $R_{th}$	K/W	0.41	0.27	0.25	0.22	0.2	Kerafol
Thermal impedance $R_{ti}$	$^{\circ}\text{Cmm}^2/\text{W}$	164	108	100	89	80	Kerafol
	$\text{Kin}^2/\text{W}$	0.25	0.18	0.15	0.14	0.12	Kerafol
Thermal conductivity $\lambda$	$\text{W/m-K}$	3.0	4.5	5.0	5.5	6.0	ASTM D5470
<b>Electrical Properties</b>							
Breakdown voltage $U_{d;ac}$	kV	6	5	1	1.25	1.5	ASTM D149
Dielectric breakdown $E_{d;ac}$	kV/mm	12	10	2	2.5	3.0	ASTM D149
Volume resistivity	$\Omega\text{m}$	$84.5 \times 10^9$	$3.6 \times 10^{12}$	$1.0 \times 10^{11}$	$16 \times 10^{12}$	$1.7 \times 10^{10}$	ASTM D257-3
Dielectric loss factor $\tan \sigma$	1	$145 \times 10^{-3}$	$3.0 \times 10^{-3}$	$1.5 \times 10^{-3}$	$1.0 \times 10^{-3}$	$2.0 \times 10^{-3}$	ASTM D150
Dielectric constant $\epsilon_r$	1	3.77	2.5	3.9	2.7	2.5	ASTM D150
<b>Mechanical Properties</b>							
Measured thickness (+/-10%)	mm	0.500	0.500	0.500	0.500	0.500	ASTM D734
Hardness	Shore 00	35 - 50	65 - 75	65 - 75	50 - 65	60 - 75	ASTM D2240
Young's Modulus	$\text{N/cm}^2$	64	94.5	70	98.5	77	ASTM D412
<b>Physical Properties</b>							
Operating temperature	$^{\circ}\text{C}$	-40 to +180	-40 to +180	-60 to +200	-40 to +180	-60 to +180	Kerafol
Density	$\text{g/cm}^3$	1.95	1.32	1.33	1.18	1.28	Kerafol
Flame rating	UL 94	VO	VO	VO	VO	VO	U.L. E140693
Total Mass Loss (TML)	Ma.-%	<0.35	<0.40	<0.24	<0.35	<0.40	ASTM E 595
Thickness available	mm	0.5 - 4.0	0.5 - 4.0	0.5 - 2.0	0.5 - 4.0	1.0 - 1.5	Kerafol

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### Reinforced Compressible Thermally Conductive Silicone Pad

Properties	Unit	86/128	86/200	86/228	86/238	Test Method
Colour	-	Orange	Pink/yellow	Yellow	Yellow	Visual
Reinforcement	-	86/52	86/52	86/52	86/52	Visual
<b>Thermal Properties</b>						
Thermal resistance $R_{th}$	K/W	0.8	1.2	0.6	0.6	Kerafol
Thermal impedance $R_{ti}$	$^{\circ}\text{Cmm}^2/\text{W}$	322	480	240	240	Kerafol
	$\text{Kin}^2/\text{W}$	0.5	0.75	0.37	0.37	Kerafol
Thermal conductivity $\lambda$	$\text{W/m-K}$	1.5	1.0	2.0	3.0	ASTM D5470
<b>Electrical Properties</b>						
Breakdown voltage $U_{d,ac}$	kV	6	8	6	6	ASTM D149
Dielectric breakdown $E_{d,ac}$	kV/mm	12	16	12	12	ASTM D149
Volume resistivity	$\Omega\text{m}$	$61.3 \times 10^9$	$1.0 \times 10^{11}$	$2.2 \times 10^{11}$	$176.1 \times 10^9$	ASTM D257-3
Dielectric loss factor $\tan \sigma$	1	$153 \times 10^{-3}$	$1.5 \times 10^{-3}$	$1.0 \times 10^{-3}$	$20.2 \times 10^{-3}$	ASTM D150
Dielectric constant $\epsilon_r$	1	4.28	3.9	3.6	3.7	ASTM D150
<b>Mechanical Properties</b>						
Measured thickness (+/-10%)	mm	0.500	0.500	0.500	0.500	ASTM D734
Hardness	Shore 00	10 - 25	10 - 20	30 - 45	25 - 40	ASTM D2240
Young's Modulus	$\text{N/cm}^2$	23.6	22	58	32	ASTM D412
<b>Physical Properties</b>						
Operating temperature	$^{\circ}\text{C}$	-40 to +180	-60 to +200	-40 to +180	-40 to +180	Kerafol
Density	$\text{g/cm}^3$	2.0	1.61	1.65	1.65	Kerafol
Flame rating	UL 94	VO	VO	VO	VO	U.L. E140693
Total Mass Loss (TML)	Ma.-%	<0.29	<0.40	<0.44	<0.10	ASTM E 595
Thickness available	mm	0.5 - 4.0	0.5 - 5.0	0.5 - 4.0	0.5 - 2.0	Kerafol

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